

1M x 4 Static RAM

Features

- · High speed
 - $-t_{AA} = 10 \text{ ns}$
- · Low active power for 10 ns speed
 - 540 mW (max.)
- Low CMOS standby power (L version)
 - 1.8 mW (max.)
- 2.0V Data Retention (400 μW at 2.0V retention)
- Automatic power-down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with $\overline{\text{CE}}$ and $\overline{\text{OE}}$ features

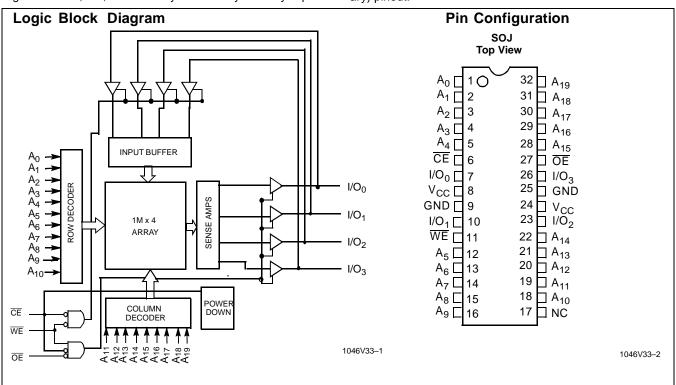
Functional Description

The CY7C1046V33 is a high-performance CMOS static RAM organized as 1,048,576 words by 4 bits. Easy memory expansion is provided by an active LOW Chip Enable (CE), an active LOW Output Enable (OE), and three-state drivers. Writing to the device is accomplished by taking Chip Enable (CE) and Write Enable (WE) inputs LOW. Data on the four I/O pins (I/O₀ through I/O₃) is then written into the location specified on the address pins (A_0 through A_{10}).

Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The four input/output pins (I/O₀ through I/O₃) are placed in a high-impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation (\overline{CE} LOW, and \overline{WE} LOW).

The CY7C1046V33 is available in a standard 400-mil-wide 32-pin SOJ package with center power and ground (revolutionary) pinout.



Selection Guide

		7C1046V33-10	7C1046V33-12	7C1046V33-15
Maximum Access Time (ns)	10	12	15	
Maximum Operating Current (mA)		150	140	130
Maximum CMOS Standby	Com'l	8	8	8
Current (mA)	L version	0.5	0.5	0.5

Shaded areas contain pre-release information.





Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied–55°C to +125°C Supply Voltage on $\rm V_{CC}$ to Relative $\rm GND^{[1]}$ –0.5V to +4.6V DC Voltage Applied to Outputs in High Z State $^{[1]}$-0.5V to $^{[1]}$ voltage $^{[1]}$-0.5V DC Input Voltage^[1].....-0.5V to V_{CC} + 0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage(per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	.>200 mA

Operating Range

Range Ambient Temperature ^[2]		V _{CC}
Commercial	0°C to +70°C	3.0V - 3.6V

Electrical Characteristics Over the Operating Range

Parameter	Description	Test Condit	ions	7C1046V33-10		7C104	6V33-12	7C104	6V33-15	
				Min.	Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min., I_{OH} = -4$.0 mA	2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	$V_{CC} = Min., I_{OL} = 8.0$) mA		0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage				V _{CC} + 0.5	2.2	V _{CC} + 0.5	2.2	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage[1]				0.8	-0.5	0.8	-0.5	0.8	V
I _{IX}	Input Load Current	$GND \le V_I \le V_{CC}$		-1	+1	-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	$\begin{array}{l} \text{GND} \leq \text{V}_{\text{OUT}} \leq \text{V}_{\text{CC}}, \\ \text{Output Disabled} \end{array}$			+1	-1	+1	-1	+1	μΑ
I _{CC}	V _{CC} Operating Supply Current	$V_{CC} = Max.$ $f = f_{MAX} = 1/t_{RC}$			150		140		130	mA
I _{SB1}	Automatic CE Power-Down Current —TTL Inputs	$\begin{aligned} &\text{Max. V}_{\text{CC}}, \overline{\text{CE}} \geq \text{V}_{\text{IH}} \\ &\text{V}_{\text{IN}} \geq \text{V}_{\text{IH}} \text{ or} \\ &\text{V}_{\text{IN}} \leq \text{V}_{\text{IL}}, \ f = f_{\text{MAX}} \end{aligned}$			20		20		20	mA
I _{SB2}	Automatic CE	Max. V _{CC} ,	Com'l		8		8		8	mA
	Power-Down Current —CMOS Inputs	$\overline{CE} \ge V_{CC} - 0.3V,$ $V_{IN} \ge V_{CC} - 0.3V,$ or $V_{IN} \le 0.3V,$ f=0	L version		0.5		0.5		0.5	

Shaded areas contain pre-release information.

Capacitance^[3]

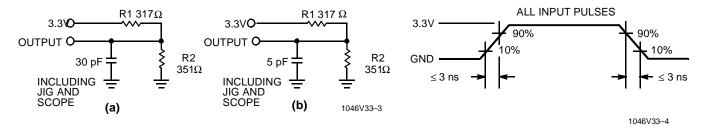
Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C$, $f = 1$ MHz,	6	pF
C _{OUT}	I/O Capacitance	$V_{CC} = 3.3V$	6	pF

Note:

- 1. V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
- T_A is the "Instant On" case temperature.
 Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms



THÉVENIN EQUIVALENT Equivalent to: 167Ω

Switching Characteristics^[4] Over the Operating Range

		7C104	7C1046V33-10 7C1046V33-12		7C1046V33-15			
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYCLE								
t _{RC}	Read Cycle Time	10		12		15		ns
t _{AA}	Address to Data Valid		10		12		15	ns
t _{OHA}	Data Hold from Address Change	3		3		3		ns
t _{ACE}	CE LOW to Data Valid		10		12		15	ns
t _{DOE}	OE LOW to Data Valid		4		6		7	ns
t _{LZOE}	OE LOW to Low Z ^[6]	0		0		0		ns
t _{HZOE}	OE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{LZCE}	CE LOW to Low Z ^[6]	3		3		3		ns
t _{HZCE}	CE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{PU}	CE LOW to Power-Up	0		0		0		ns
t _{PD}	CE HIGH to Power-Down		10		12		15	ns
WRITE CYC	CLE ^[7, 8]							
t _{WC}	Write Cycle Time	10		12		15		ns
t _{SCE}	CE LOW to Write End	7		8		10		ns
t _{AW}	Address Set-Up to Write End	7		8		10		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		ns
t _{PWE}	WE Pulse Width	7		8		10		ns
t _{SD}	Data Set-Up to Write End	5		6		8		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[6]	3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[5, 6]		5		6		7	ns

Shaded areas contain pre-release information.

Notes:

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified $I_{\rm OL}/I_{\rm OH}$ and 30-pF load capacitance.
- tHZOE, HIZCE, and tHZWE are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
- At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZOE} is less than t_{LZCE}, and t_{HZWE} is less than t_{LZCE} is less than t



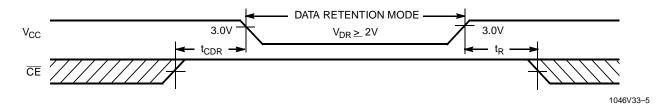
Data Retention Characteristics Over the Operating Range

Parameter	Description		Conditions ^[10]	Min.	Max	Unit
V_{DR}	V _{CC} for Data Retention			2.0		V
I _{CCDR}	Data Retention Current	Com'l	$\underline{V_{CC}} = V_{DR} = 2.0V,$		200	μΑ
t _{CDR} ^[3]	Chip Deselect to Data Retention Time		$CE \ge V_{CC} - 0.3V$ $V_{IN} \ge V_{CC} - 0.3V$ or $V_{IN} \le 0.3V$	0		ns
t _R ^[9]	Operation Recovery Time		1 1 1 1 2 1 CC 3.5 1 5 1 1 1 1 2 5.5 1	10		μs

Notes:

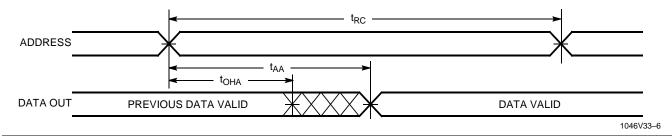
- 9. $t_r \le 3$ ns for the -10, -12, and -15 speeds.
- 10. No input may exceed V_{CC} + 0.5V.

Data Retention Waveform

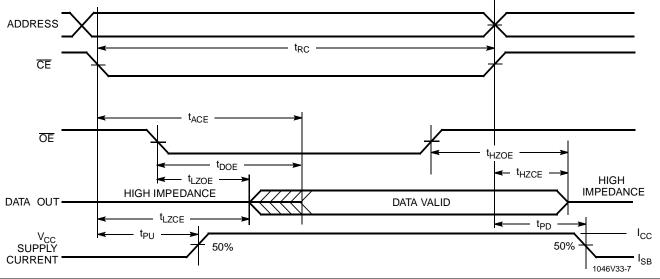


Switching Waveforms

Read Cycle No. 1^[11, 12]



Read Cycle No. 2 (OE Controlled)[12, 13]



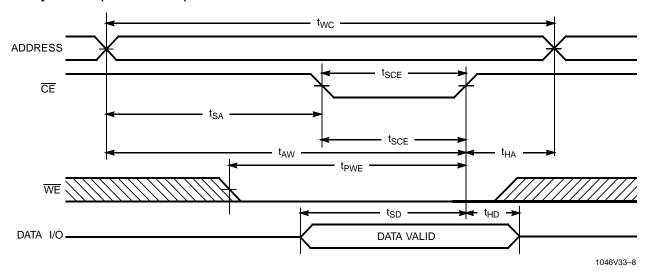
Notes:

- Device is continuously selected. OE, CE = V_{IL}.
 WE is HIGH for read cycle.
 Address valid prior to or coincident with CE transition LOW.

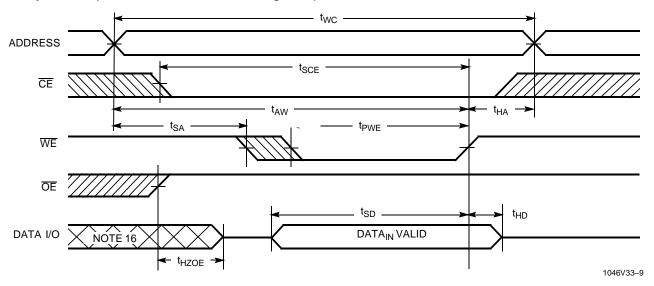


Switching Waveforms (continued)

Write Cycle No. 1 (CE Controlled)[14, 15]



Write Cycle No. 2 (WE Controlled, OE HIGH During Write)[14, 15]



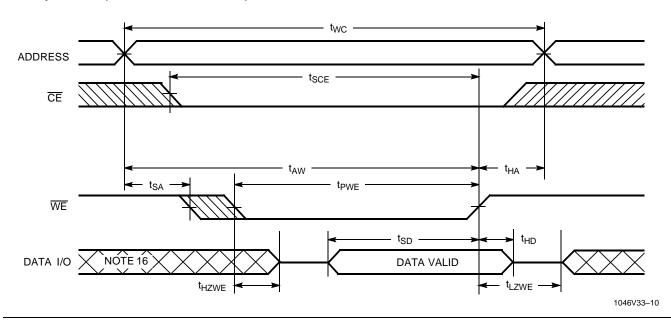
Notes:

- 14. Data I/O is high impedance if OE = V_{IH}.
 15. If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.
 16. During this period the I/Os are in the output state and input signals should not be applied.



Switching Waveforms (continued)

Write Cycle No. 3 ($\overline{\text{WE}}$ Controlled, $\overline{\text{OE}}$ LOW)[15]



Truth Table

CE	OE	WE	I/O ₀ - I/O ₇	Mode	Power
Н	Х	Х	High Z	Power-Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I _{CC})

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C1046V33-10VC	V33	32-Lead (400-Mil) Molded SOJ	Commercial
12	CY7C1046V33-12VC	V33	32-Lead (400-Mil) Molded SOJ	
15	CY7C1046V33-15VC	V33	32-Lead (400-Mil) Molded SOJ	
10	CY7C1046V33L-10VC	V33	32-Lead (400-Mil) Molded SOJ	
12	CY7C1046V33L-12VC	V33	32-Lead (400-Mil) Molded SOJ	
15	CY7C1046V33L-15VC	V33	32-Lead (400-Mil) Molded SOJ	

Shaded areas contain pre-release information.

Document #: 38-00764



Package Diagram

32-Lead (400-Mil) Molded SOJ V33

